

Keithley Instruments has long been an industry leader in both overall parametric test technology and wafer level reliability (WLR) testing.

Several generations of Keithley's parametric test solutions have offered WLR test algorithm libraries as options. That gives us decades of experience in creating integrated hardware and software solutions for emerging test needs in device characterization, semiconductor parametric test, and electrical parametric process monitoring. Plus, our years of working with WLR users at every technology node have given us an in-depth understanding of the changing needs associated with reliability testing.



Key Applications

- Device Reliability
 - Hot Carrier Injection (HCI)
 - Negative Bias Temperature Instability (NBTI)
 - Positive Bias Temperature Instability (PBTI)
 - Ultra-Fast BTI
- · Gate Oxide Integrity
 - Time Dependent Dielectric Breakdown (TDDB)
 - Voltage Ramp (VRAMP)
 - Current Ramp (JRAMP)
 - High voltage GOI
- Metal Interconnect
 - Isothermal Electro-migration (EM)
 - Poly Heater Conkstant Current
 - Interlayer Dielectric Time Dependent
 Dielectric Breakdown (ILD TDDB)







Keithley WLR Solutions

ULTRA-FAST BTI SOLUTIONS

BTI test is a fast phenomenon that requires ultra-fast and sensitive measurements for accurate characterization.

SMU PER PIN PARALLEL SOLUTION

Most reliability tests require a lot of time. ACS WLR SMUper-pin systems provide high-throughput, parallel device capability for WLR.

CUSTOMIZED SOLUTION

Configure your system to optimize your WLR testing.







4200A-SCS Parameter Analyzer

- Remote pulse pre-amplifiers: 4225-RPM Remote Amplifier/Switches
- Transistor VT characterization in less than 1 µs using ID-VD sweep method
- NBTI
- Electro-migration
- Hot Carrier Injection
- TDDB VRAMP, JRAMP
- Sub-site cycling with AC or DC stressing
- Includes reliability projects

SMU-per-pin System • SMU Series

- SMU Series 2600B-based system
- Proprietary TSP-Link® technology to enable fast testing
- More than 40 SMUs in a single rack
- True parallel test for multiple devices

Customized System Includes:

- 4200A-SCS Parameter Analyzer – SMU, PMU, CVU, PGU
- Series 2600B Series High speed SMU
- 707B Switch Matrix Mainframe – Precision matrix cards 7174A. 7530
- 2450, 2460 Source Measure Units
- 3706 Switch Matrix

Key Specifications

ACS WLR

- Supports high power device Vds Ramp and HTRB test
- Fully-automated capabilities to test individual wafers or an entire cassette
- Software for flexible test setup and parallel testing
- Reliability test module (RTM) complies with JEDEC standard test methodologies
- Supports creation of customized test module/procedures

4200A-SCS Parameter Analyzer

- Lab grade semiconductor parameter analyzer
- Optional 4200-BTI-A Package
- 200 V, 1 A max Source Measure Unit (SMU) Instrument
- Ultra-low current measurement:
 10 aA current resolution Preamp
- Ultra-fast measurement during pulse: 5 nsec time resolution for measurement pulse measure unit (PMU)
- 1 kHz to 10 MHz multi-frequency capacitance-voltage measurement unit (CVU)

Series 2600B High-Speed SMU Instrument

- 3 kV max
- 10 A max pulse mode / 3 A max DC
- TSP-Link Technology Synchronize between SMUs / Multiple SMUs function as one instrument

707B/7174A/7530 High Speed and Low Current Matrix

- Low leakage (<100 fA offset on all signal paths)
- High speed (<4 msec switching time)
- 200 V, 2 A carry signal
- 8×12 configuration per card
- Max 6 matrix cards up to 72 pins

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4200A-BTI-A Ultra-Fast Solution

- ACS Software with wafer mapping on-the-fly
- Ultra-fast BTI test module
- BTI degradation characterized 30 nano-seconds after stress



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